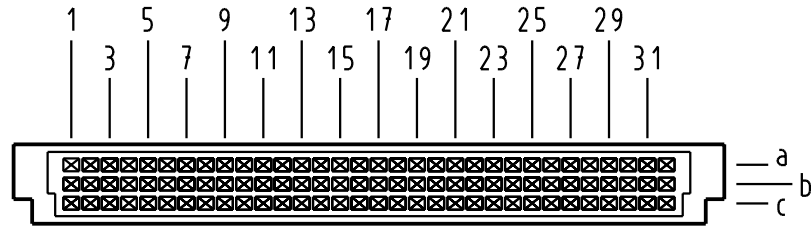


Y Kontaktanordnung Contact arrangement

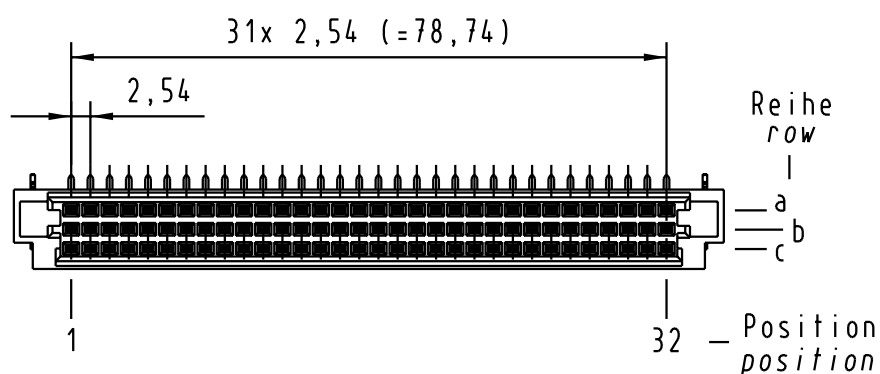
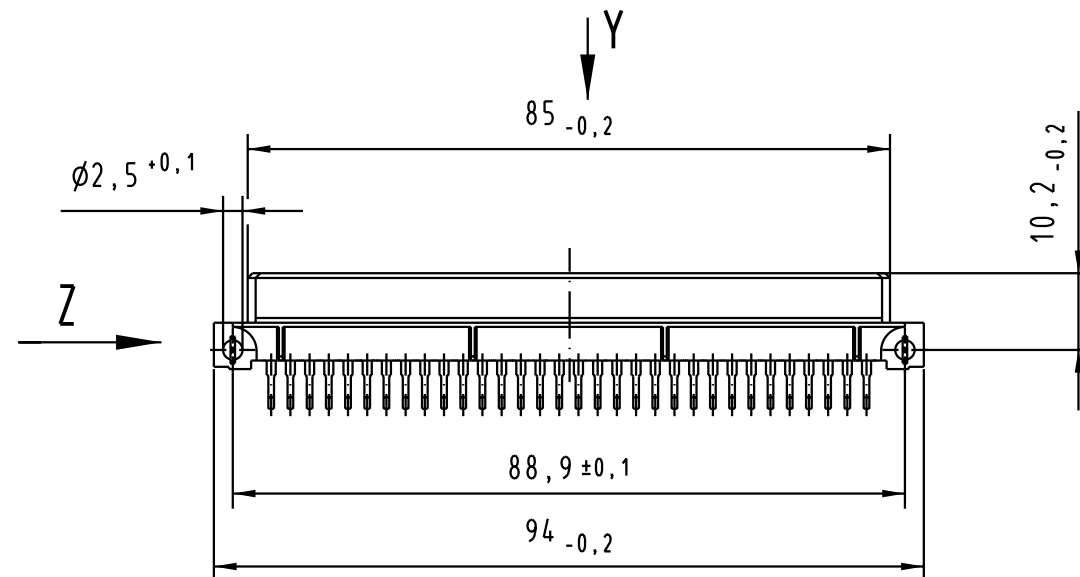
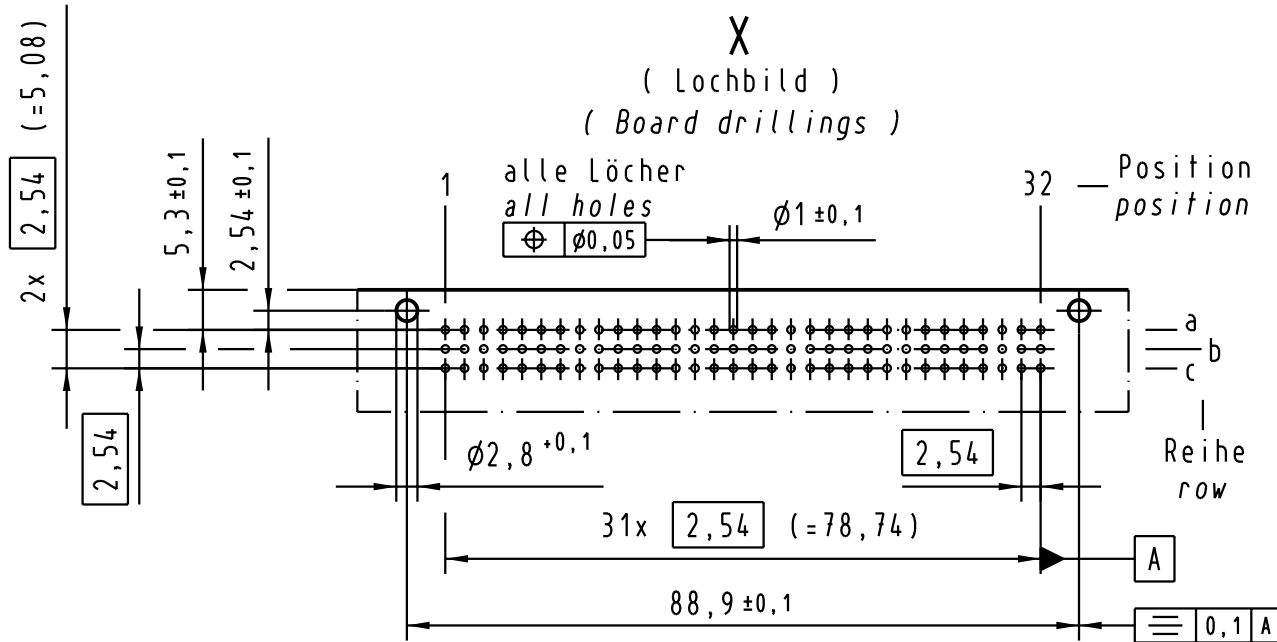


96 Signal Kontakte
96 signal contacts

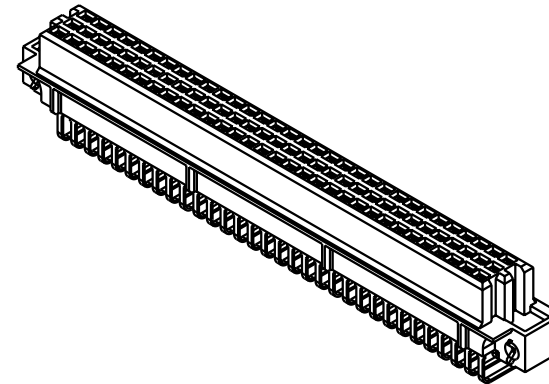
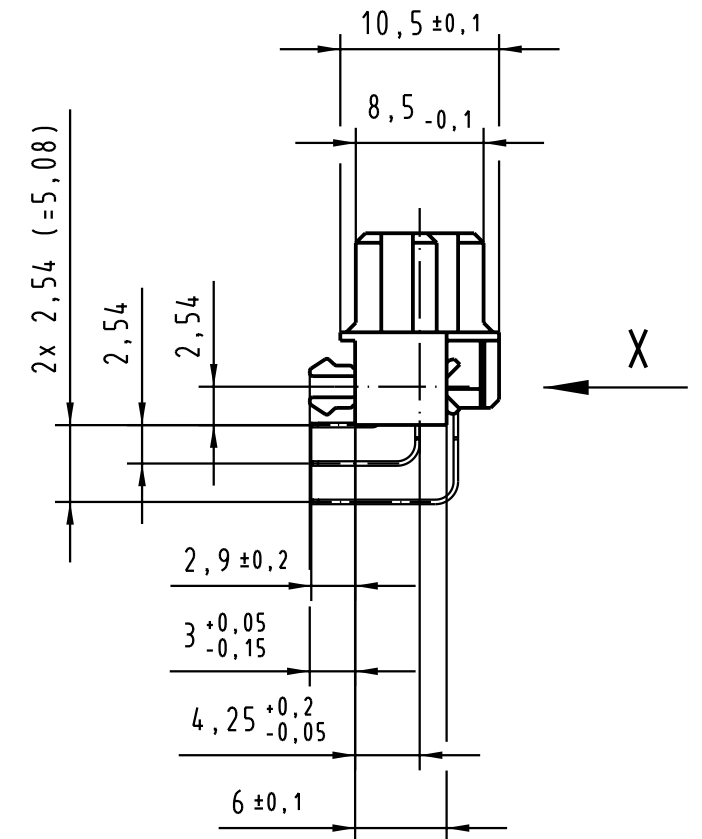
⊗ = Kontaktposition belegt
= position with contact

○ = Kontaktposition nicht belegt
= position without contact

X (Lochbild) (Board drillings)



Z
2:1



09 79 496 5801	—	min. 0,76µm (30µin) Au über/over min. 1,27µm (50µin) Ni
09 79 496 7801	3	Au über/over Ni
09 79 496 6801	2	Au über/over Ni
09 79 496 2801	1	Au über/over Ni
Bestell-Nr. Part-No.	Anforderungsstufe nach IEC performance level per IEC	Kontaktoberfläche Contact Plating

All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maß/Free size tolerances siehe / see IEC 60603-2	
				Dat.	Name	Maßstab/Scale 1:1 2:1	har-bus R LM Federleiste mit Clip Einlötl, 96 pol. har-bus R LM female connector with clip solder, 96 pol.
				Detail.	13.09.99 Rie.		
				Insp.	13.09.99 Pa.		
31034	05.06.02	Rie.	Stand.			HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP	TB 09 79 496 x801
27555	04.02.00	Rie.					
26086							
Mod.	Dat.	Name					Blatt 11 / page

